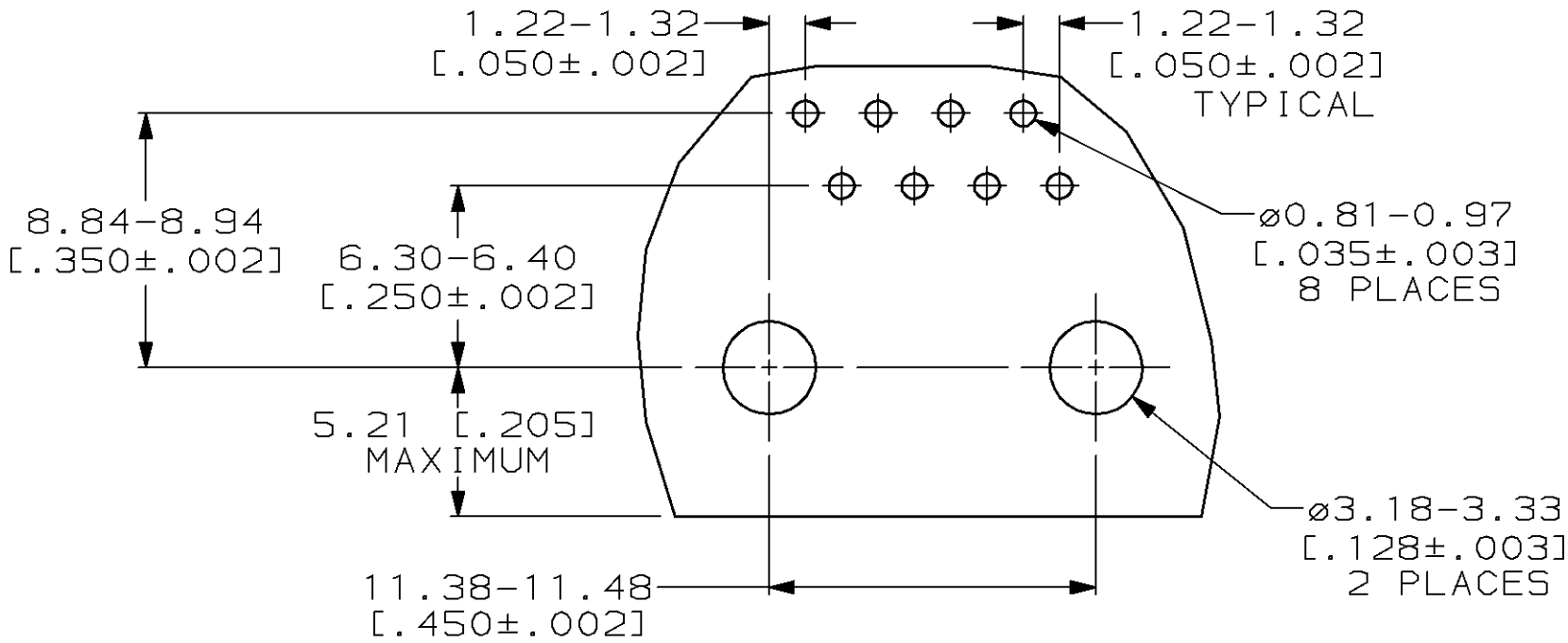
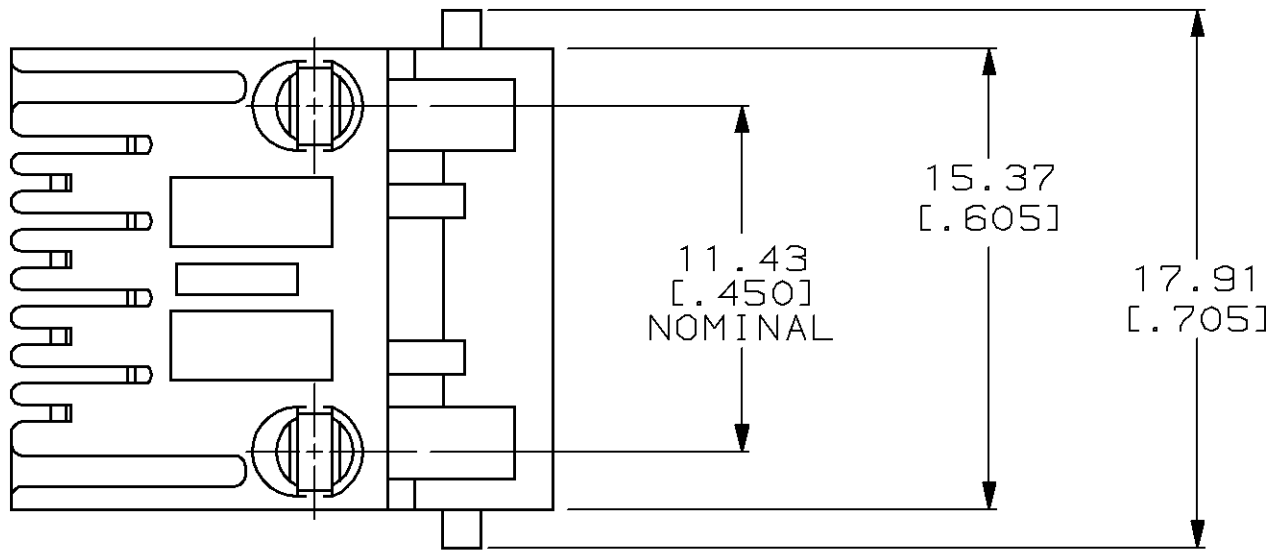
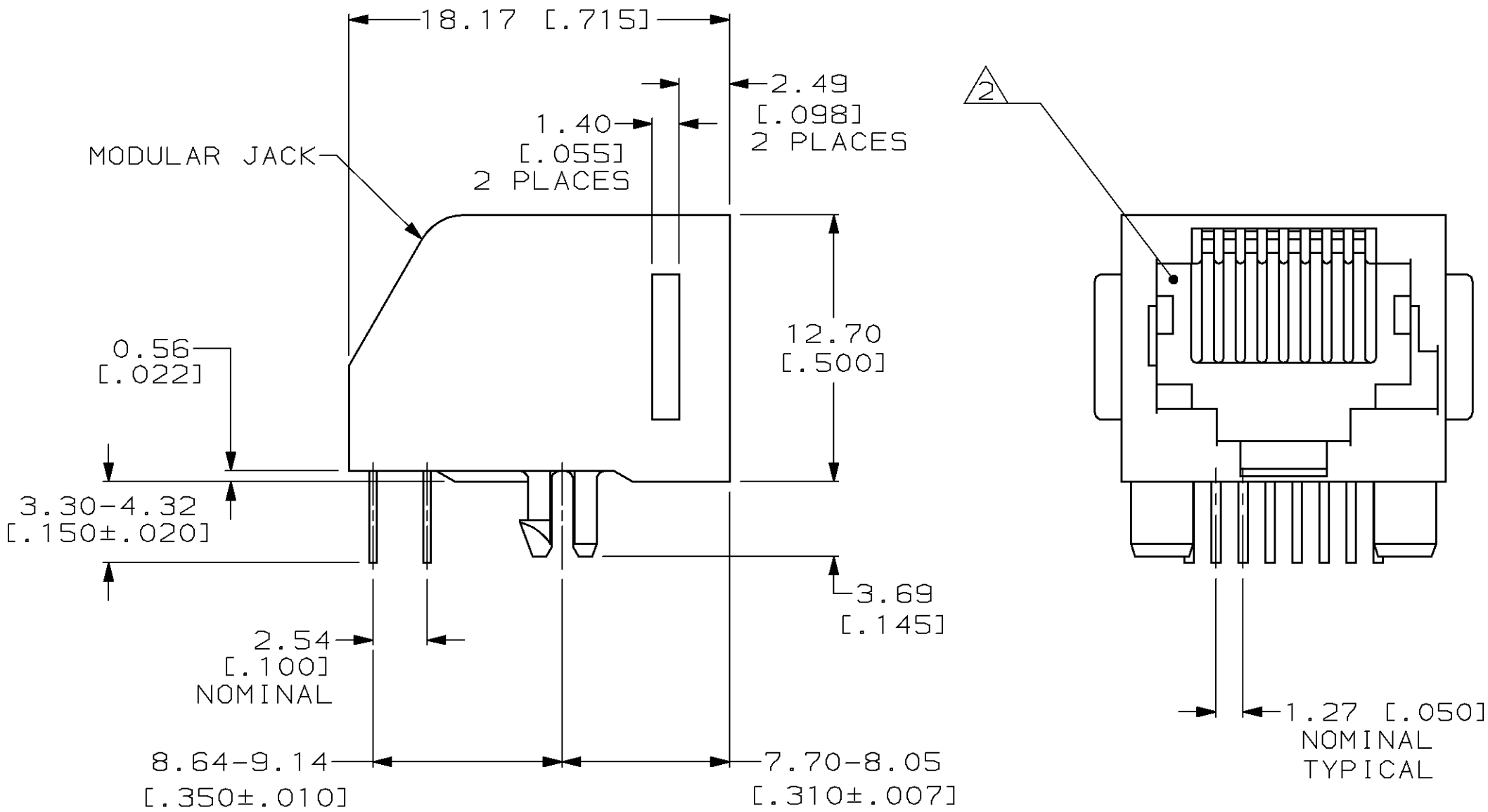


LOC	DIST	P	F	ZONE	LTR	DESCRIPTION	DATE	APPD
AA	22				H	OBS: -3; EC 0502-0846-97	21MAY98	DS CB



SUGGESTED PRINTED CIRCUIT BOARD
MOUNTING HOLE LAYOUT
LAYOUT SHOWN FROM CIRCUIT SIDE OF BOARD

THIS DRAWING IS A CONTROLLED DOCUMENT FOR
AMP INCORPORATED. IT IS SUBJECT TO CHANGE
AND THE CONTROLLING ENGINEERING ORGANIZATION
SHOULD BE CONTACTED FOR THE LATEST REVISION.

- 1 MATERIAL: HOUSING - PBT POLYESTER, BLACK.
TERMINAL - 0.36 [.014] THICK PHOS BRONZE PLATED WITH 1.27μm [.000050] THICK HARD GOLD IN LOCALIZED GOLD PLATE AREA AND 2.03μm [.000080] THICK TIN LEAD IN SOLDER AREA OVER 1.27μm [.000050] THICK NICKEL UNDERPLATE.
- 2 CAVITY CONFORMS TO FCC RULES AND REGULATIONS PART 68, SUBPART F.
- 3 DIMENSIONS ARE MAXIMUM UNLESS OTHERWISE SPECIFIED.

		8	555166-1	
		TERMINALS	PART NO	
DO NOT SCALE PRINT. UNLESS SPECIFIED DIMENSIONS IN mm [INCHES] TOLERANCES ON : 2 PLC DEC ± - 3 PLC DEC ± - ANGLES ± -		DR 11-8-95 D. STRAUSSER CHK 11-14-95 N. JONES APPD 11-20-95 J. TONEY APPD 11-20-95 H. MCGRATH PRODUCT SPEC 108-1163 APPLICATION SPEC 114-2048 WEIGHT -	AMP Incorporated Harrisburg, PA 17105-3608 NAME MODULAR JACK ASSEMBLY 8 POSITION, LOW PROFILE, RIGHT ANGLE, KEYED, WITH PANEL STOPS SIZE CAGE CODE DRAWING NO SCALE 4:1	
			00779	C=555166
			SHEET	1 OF 1